Inelastic scattering and current saturation in graphene

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We present a study of transport in graphene devices on polar insulating substrates by solving the Boltzmann transport equation in the presence of graphene phonon, surface polar phonon, and Coulomb charged impurity scattering. The value of the saturated velocity shows very weak dependence on the carrier density, the nature of the insulating substrate, and the low-field mobility, varied by the charged impurity concentration. The saturated velocity of $4 \times 10^7 - 8 \times 10^7$ cm/s calculated at room temperature is significantly larger than reported experimental values. The discrepancy is due to the self-heating effect which lowers substantially the value of the saturated velocity. We predict that by reducing the insulator oxide thickness, which limits the thermal conductance, the saturated currents can be significantly enhanced. We also calculate the surface polar phonon contribution to the low-field mobility as a function of carrier density, temperature, and distance from the substrate.

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I. INTRODUCTION

The excellent transport¹⁻⁴ and optical properties of graphene⁵ have attracted strong interest in possible applications of this material in nanoscale electronics and optoelectronics.^{6–8} The electrostatic modulation of the graphene channel through gates yields very promising twodimensional (2D) field-effect devices for analog and radiofrequency applications.^{9,10} Such devices should ideally be operated in the saturation limit.¹¹ Indeed, it has been shown that the current saturates as the source-drain field is increased to a few volts per micron.^{11–13} While elastic scattering determines the low-field mobility, the current saturation has been attributed due to the inelastic scattering by either surface polar phonons (SPP) of the polar substrates^{11,12} or the intrinsic graphene optical phonons.¹³ In addition to the uncertainty on the nature of the inelastic scattering mechanism, significant heating of the graphene devices operated under high bias conditions is expected. This has recently been measured by Raman spectroscopy.^{12,14} However, little is known about the role of self-heating and elastic scattering on the current saturation.

High bias measurements in graphene^{11–13} were analyzed by analogy to one-dimensional carbon nanotubes, where the magnitude of the saturated current is determined by the optical phonon energy responsible for the saturation. However, *a priori* an extension of the simple analytical model for the saturated velocity in 2D graphene, as an inverse of the square root of the carrier density, may not be applicable. In Ref. 15, using hydrodynamic transport theory including graphene optical phonon scattering, the saturation velocity was found to be weakly carrier-density dependent, whereas in Ref. 16, using a Monte Carlo solution of the Boltzmann transport equation (BTE), the saturated velocity was found to follow an inverse square-root dependence on the carrier density.

In this work, we explore the effects of Coulomb impurity, graphene phonon, and SPP scattering on different polar substrates on the current saturation in the diffusive transport regime. We find that the self-heating of graphene on SiO_2 limits significantly the value of the saturated current. The electronic structure of graphene is described by a π -orbital tight-binding model with a hopping parameter $t_0=3.1$ eV, which gives a Fermi velocity $v_F = (\sqrt{3}/2)t_0 a/\hbar \approx 10^6$ m/s, where a=0.246 nm is the graphene lattice constant. For the electron-phonon scattering we use the Su-Schrieffer-Heeger (SSH) model¹⁷ to express the modulation of the π -orbital overlap $t=t_0-g\,\delta R_{\rm CC}$ with C-C distance $R_{\rm CC}$. The electronoptical phonon scattering has been calculated by first principles.^{18,19} It was found that SSH reproduces fairly well the local-density approximation results for the electronoptical phonon scattering if $g \approx 4.5 \text{ eV}/\text{Å}$.¹⁸ On the other hand, electron-electron correlations, taken into account using the GW approximation,²⁰ give electron-K-point opticalphonon coupling corresponding to $g \approx 6.5 \text{ eV/Å}$ and coupling to Γ -point phonons to give $g \approx 5.3 \text{ eV}/\text{Å}$. Therefore, it is expected that electron-phonon coupling in graphene can be renormalized depending on the environment which will screen the electron-electron interactions. In this work we use an average value of $g=5.3 \text{ eV}/\text{\AA}$ as in Ref. 21. The parameters used for SPP scattering on SiO₂, HfO₂, SiC, and BN polar substrates are given in Table I.

II. LOW-FIELD MOBILITY

The low-field mobility in pristine graphene, in the absence of charged impurities and defects, is determined by scattering from the graphene phonons and it is shown in Fig. 1. There are two acoustic-phonon branches, transverse acoustic (TA) and longitudinal acoustic (LA), with an appreciable electron-phonon coupling. Within the SSH model, the TA and LA modes have different angle dependencies for the electron-phonon couplings $|M_{k,k+q}|^2 = D_{ac}^2 q^2 \hbar/(8NM_C \omega_q) \times \{1 \pm \cos[3(\theta_k + \theta_{k+q})]\}$ ²⁶ where D_{ac} is a deformation potential, θ_k is a directional angle of wave vector k,²⁷ ω_q is a phonon frequency, M_C is a mass of carbon atom, and N is a number of k points. Therefore, the acoustic-phonon coupling can be approximated by $|M_{k,k+q}|^2 = D_{ac}^2 q \hbar/(4NM_C v_{ph})$, where v_{ph} is a characteristic (LA/TA) sound velocity. The value of deformation potential is given by:²⁶ $D_{ac} = 3ga\kappa/(4\sqrt{3})$, where the reduction factor $\kappa = v_{TA}^2/(v_{LA}^2 - v_{TA}^2)$ was introduced in

TABLE I. Parameters for the SPP scattering for graphene on SiO₂, HfO₂, SiC, and hexagonal BN substrates. The surface optical (SO) phonon energies are obtained from the bulk longitudinal-optical (LO) phonons as $\hbar\omega_{\rm SO} = \hbar\omega_{\rm LO} (\frac{1+1/\epsilon_0}{1+1/\epsilon})^{1/2}$.

	SiO ₂ ^a	HfO ₂ ^b	SiC ^c	h-BN ^d
$\overline{\varepsilon_0}$	3.9	22.0	9.7	5.09
ε_i	3.36	6.58		4.575
ε_{∞}	2.40	5.03	6.5	4.10
$\hbar\omega_{\rm SO_1}$ in meV	58.9	21.6	116.0	101.7
$\hbar \omega_{\rm SO_2}$ in meV	156.4	54.2		195.7
F_1^2 in meV	0.237	0.304	0.735	0.258
F_2^2 in meV	1.612	0.293		0.520

^aReference 22.

^bReference 23.

^cReference 24.

^dReference 25.

Refs. 28 and 29. For the valence phonon model³⁰ used here we obtain $D_{ac} \approx 3.7$ eV, consistent with the numerical calculations.

The low-field mobility μ can be found using Boltzmann theory $\sigma = en\mu = e^2 v_F^2 D_n \tau/2$, where σ is the conductivity, *n* is the carrier density, $D_n = 2E_F / (\pi \hbar^2 v_F^2)$ is the density of states, $E_F \approx \hbar v_F \sqrt{\pi n}$ is the Fermi energy, and τ is the scattering time. The latter can be found as



FIG. 1. (Color online) Temperature dependence of the low-field mobility in graphene on different substrates from top to bottom: green circles - intrinsic, black open circles - on BN, cyan squares - on SiC, red triangles - on SiO₂, and blue diamonds - on HfO₂ at carrier densities (a) $n=10^{12}$ cm⁻² and (b) $n=5\times10^{12}$ cm⁻². The solid curves are results using Eq. (6) with characteristic sound velocity $v_{ph}=17.3$ km/s, energy of the optical phonon in graphene $\hbar\omega_{op}=0.19$ eV. We provide numerical values for the calculated mobilities at room temperature to be compared with the fit using Eq. (6) from top to bottom in (a) - 687000, 113000, 81500, 25900, 4300 cm²/Vs; in (b) - 144000, 37300, 26900, 11000, 2200 cm²/Vs.

$$\frac{1}{\tau_k} = \frac{2\pi}{\hbar} \sum_q |M_{k,k+q}|^2 [1 - \cos(\theta_k - \theta_{k+q})] \\ \times [N_q \delta(E_k - E_{k+q} + \hbar\omega_q) + (N_q + 1) \delta(E_k - E_{k+q} - \hbar\omega_q)],$$
(1)

where N_q is the Bose-Einstein phonon occupation number. The summation in Eq. (1) is replaced by the integral $(1/N)\Sigma_q = A/(4\pi^2)\int q dq d\theta$ (sum over one spin and one valley), where $A = \sqrt{3a^2/2}$ is the area of the two atom unit cell. The low-field mobility and the scattering rate in the high-temperature *T* limit are given by

$$\mu_{ac} = \frac{e\rho_m \hbar v_F^2 v_{ph}^2}{\pi D_{ac}^2} \frac{1}{nk_B T},$$

$$\frac{1}{\tau_k} = \frac{1}{\hbar^3} \frac{E_k}{v_F^2} \frac{D_{ac}^2}{\rho_m v_{ph}^2} k_B T,$$
 (2)

where $\rho_m = 2M_C / A \approx 7.66 \times 10^{-11} \text{ kg/cm}^{-2}$ is the graphene mass density. Note a numerical difference of a factor of 4 in Eq. (2) for τ used in the literature,^{26,31} due to the different angular dependencies of the electron-acoustic phonon scattering used in Refs. 15, 31, and 32. This discrepancy leads, in part, to the large range of deformation potential values from $D_{ac} = 10$ to 30 eV quoted in the literature.^{33–37} In addition, uncertainty in the sound velocity can also contribute to the spread of the values of the deformation potentials. For example, the deformation potential extracted from the resistivity temperature dependence in graphene on SiO_2 at n $=10^{12}$ cm⁻² in Ref. 36 would give $D_{ac}=7.1$ eV, if Eq. (2) is used with v_{ph} =17.3 km/s.³⁰ The measurements for the electron branch in suspended graphene at n=2×10¹¹ cm⁻² in Ref. 35 would correspondingly give $D_{ac}=12$ eV. When quantifying the acoustic scattering in different studies it would, therefore, help to report not only the value of D_{ac} , but also that of the low-field conductivity extrapolated to room temperature. In our model, it corresponds to $\sigma_{ac}(T)$ =300 K) \approx 0.1 S. Note that in low-mobility samples, due to charged sites in the substrate, an additional temperature dependence from Coulomb scattering may arise.³⁸

The two optical phonons at the Γ point have couplings $|M_{k,k+q}^{s,s'}|^2 = D_{\Gamma}^2 \hbar/(2NM_C\omega_{\Gamma})[1 \pm ss' \cos(\theta_k - \theta_{k+q})]$ for longitudinal-optical (LO) (-sign) and transverse-optical (TO) (+sign) modes, respectively,^{18,39} where $D_{\Gamma} = 3g/\sqrt{2}$ $\approx 11.2 \text{ eV/Å}$,⁴⁰ s = 1 for electrons and s = -1 for holes. The *K*-point TO phonon mode has an electron-phonon coupling twice as large,^{18,21} with the angle dependence given by $|M_{k,k+q}^{s,s'}|^2 = D_{\Gamma}^2 \hbar/(NM_C\omega_K)[1-ss'\cos(\theta_k - \theta_{k+q})]$.¹⁸ The effect of the optical phonons (both at Γ and K) on the low-field mobility can be calculated according to⁴¹

$$\mu_{op} = \frac{e\rho_m v_F^2 \omega_{op}}{2\pi D_{op}^2} \frac{1}{nN_{op}},\tag{3}$$

where $D_{op}=2D_{\Gamma}=22.4 \text{ eV/Å}$ is an effective electron-optical phonon coupling. The angle integration in Eq. (1) for *K*-point phonons gives a factor of 3/2 larger contribution than that for Γ -point phonons scattering.

INELASTIC SCATTERING AND CURRENT SATURATION ...

The SPP phonons on polar substrates produce an electric field that couples to the electrons on the nearby graphene. While the SPP scattering is of lesser importance in conventional metal-oxide-semiconductor field-effect transistors,²³ it is much more prominent in graphene and carbon nanotubes due to the much smaller vertical dimension of the devices given by the van der Waals distance. It has been invoked to explain transport under both low and high bias conditions in graphene^{11,36,42,43} and carbon nanotubes⁴⁴ on polar substrates. In graphene the SPP coupling is given by^{42,43}

$$\langle \Psi_{k}^{s} | V_{\text{SPP}} | \Psi_{k+q}^{s'} \rangle |^{2} = \frac{1 + ss' \cos(\theta_{k} - \theta_{k+q})}{2} \frac{4\pi^{2} e^{2} F_{\nu}^{2}}{NAq} e^{-2qz_{0}},$$
(4)

where $z_0 \approx 3.5$ Å is the van der Waals distance between the polar substrate and the graphene flake. The magnitude of the polarization field is given by the Fröhlich coupling:⁴⁵ $F_{\nu}^2 = \frac{\hbar \omega_{SO,\nu}}{2\pi} (\frac{1}{\epsilon_{\infty} + \epsilon_{env}} - \frac{1}{\epsilon_0 + \epsilon_{env}})$, where $\hbar \omega_{SO,\nu}$ is a surface phonon energy and ϵ_0 and ϵ_{∞} are the low- and high-frequency dielectric constants of the polar substrate, see Table I. The screening of the Coulomb interaction by the environment above the polar dielectric is taken into account by ϵ_{env} . Since the screening of the electric field perpendicular to the graphene plane is weak,⁴⁶ we take $\epsilon_{env}=1$. When there are several SPP modes with an appreciable coupling, then the low- and highfrequency ϵ are understood as intermediate dielectric functions at $\omega_i \ll \omega_{SO,\nu}$ for ϵ_0 and at $\omega_i \gg \omega_{SO,\nu}$ for ϵ_{∞} .²³

As shown in Fig. 1, the SPP contribution to the low-field mobility can be well approximated by

$$\mu_{\text{SPP},\nu} \approx \sqrt{\frac{\beta}{\hbar\omega_{\nu}}} \frac{\hbar v_F}{e^2} \frac{e v_F}{F_{\nu}^2} \frac{\exp(k_0 z_0)}{N_{\text{SPP},\nu} \sqrt{n}},\tag{5}$$

which is a nonmonotonic function of carrier density n. Here $k_0 \approx \sqrt{(2\omega_{\text{SO},\nu}/v_F)^2 + \alpha n}$, where parameters $\alpha \approx 10.5$ and β $\approx 0.153 \times 10^{-4}$ eV are determined to give an overall agreement of the mobility dependence on the carrier density n and distance z_0 , as shown in Fig. 2. SiC grown graphene has an intermediate dead layer,47 which increases the effective distance z_0 and also changes the environmental screening ε_{env} . Both effects, have to be taken into account when direct comparison is made with the experiment. Note that the calculated temperature dependencies shown in Fig. 1 deviate from the scattering rate temperature dependence given by the SPP phonon occupation number $N_{\text{SPP},\nu}$. An additional temperature dependence arises from the thermal averaging of the scattering rate with the carrier distribution function. We have chosen a set of parameters α and β to agree best with the mobility at room temperature.

The calculated low-field mobility from the BTE solution in Fig. 1 can be well described using Matthiessen's rule,

$$\mu^{-1} = \mu_{ac}^{-1} + \mu_{op}^{-1} + \sum_{\nu} \mu_{\text{SPP},\nu}^{-1},$$
(6)

where mobility contributions due to the acoustic, optical, and SPP phonons are given by Eqs. (2), (3), and (5), respectively.



FIG. 2. (Color online) Carrier density of the low-field mobility in graphene on HfO₂ at T=300 K for distances from the substrate (from top to bottom) $z_0=12.5$ Å (cyan open squares), 10.0 Å (red open circles), 7.5 Å (magenta triangles), 5.0 Å (blue squares), and 3.5 Å (green circles). The solid curves are results using Eq. (5).

III. CURRENT SATURATION

At high bias, the transport in graphene is usually described by the saturated current model,^{11,21,48}

$$j = e \,\eta \frac{\mu F}{1 + \mu F/v_{sat}},\tag{7}$$

where $\eta = n_e + n_h$ is the total carrier density, v_{sat} is a saturation velocity, and *F* is an electric field. Note that in the model $\mu_e = \mu_h$. Within simple model, in the full saturation regime only carriers around the Fermi energy E_F in the energy window $E_F \pm \hbar \Omega/2$ contribute to the current. Here Ω is the characteristic frequency of the phonon responsible for the current saturation. The saturated velocity can then be calculated and for $E_F > \hbar \Omega/2$,

$$v_{sat} \approx \frac{2}{\pi} \Omega \frac{\hbar v_F}{E_F} = \frac{2}{\pi} \frac{\Omega}{\sqrt{\pi n}}.$$
 (8)

Note again a difference in the numerical prefactor used in the literature^{11–13} 1 versus $2/\pi$ which affects the numerical value of the characteristic phonon energy $\hbar\Omega$ extracted from the experiments.^{11,12}

The current densities for graphene on different substrates as a function of electric field are shown in Fig. 3. When phonons are kept in thermal equilibrium at T_{amb} =300 K, the current does not show full saturation for the experimentally relevant source-drain fields up to 2 V/ μ m. In Fig. 3(a), the current shows negative differential conductance for scattering by intrinsic graphene phonons. This behavior is due to the deviation of the band structure from the linear band dispersion, similar to the effect of the nonparabolicity in carbon nanotubes.²¹ While the current at high bias in Fig. 3 is found to be larger for graphene on polar insulators with larger SPP phonon energy, the saturated velocity as obtained from the fit to Eq. (7) does not obey Eq. (8).

First we explore the dependence of the saturated velocity on the low-field mobility. The latter is strongly affected by the quality of the substrate, which introduces Coulomb im-



FIG. 3. (Color online) Current-density electric field dependence in graphene on different polar substrates: green circles - intrinsic, black open circles - on BN, cyan squares - on SiC, red triangles - on SiO₂, and blue diamonds - on HfO₂ at carrier densities (a) n=10¹² cm⁻², (b) n=5×10¹² cm⁻², and (c) n=10¹³ cm⁻² and a lattice temperature T_{amb} =300 K. The solid curves are fits to Eq. (7).

purity scattering, ${}^{36,38,49-54}$ resonant scatterers, 32,55,56 electronhole puddles, 57 and surface roughness. 58,59 In Fig. 4(a) we show current-voltage (*I-V*) characteristics of graphene on SiO₂ with a variable Coulomb impurity concentration n_i following Ref. 52. Despite the fact that the low-field mobilities vary by a factor of 15, the saturated velocity, as obtained



FIG. 4. (Color online) (a) Current saturation in graphene on SiO₂ at different temperatures *T* in kelvin and Coulomb impurity concentration n_i in 10^{12} cm⁻²: $(T, n_i) = (300, 0.0)$ - red circles, (300, 1.35) - red squares, (600, 0.0) - blue triangles, and (600, 2.8) - blue diamonds. The solid curves are the best fits to Eq. (7) and the corresponding saturated velocities are $v_{sat} = 7.26 \times 10^7$, 7.07×10^7 , 7.15×10^7 , and 6.91×10^7 cm/s, which are the same values within 5%, despite the fact that the low-field mobilities vary by a factor of 15. (b) Calculated total carrier density as a function of the electric field for the same cases as in (a). The charge-carrier density was fixed at $n = n_e - n_h = 2 \times 10^{12}$ cm⁻².



FIG. 5. (Color online) (a) Reference velocity $v_{ref} \approx v_{sat}/2$ and (b) reference field $F_{ref} \approx v_{sat}/\mu$ dependencies on the low-field mobility. The results are obtained from the calculations at room temperature for graphene on SiO₂ for different impurity concentrations, which determine the low-field mobility (Ref. 52). Calculations are for fixed charge-carrier densities *n* (in 10^{12} cm⁻²) of 1.0 - red circles, 2.0 - blue squares, 3.0 - green diamonds, and 5.0 - cyan triangles. The black dashed curve in (b) shows $F_{ref} = v_{sat}/\mu$ dependence with $v_{sat} = 8 \times 10^7$ cm/s.

from the fit to Eq. (7), is essentially the same. The electronic temperature increases with the electric field, such that minority carriers contribution to the current becomes significant. This effect is more pronounced at elevated lattice temperatures as shown in Fig. 4(b).

The systematic behavior of the low-field mobility, which is modified by the impurity concentration, on the saturated velocity is shown in Fig. 5. Since the current does not fully saturate even at large fields, we have chosen to plot in Fig. 5 a reference velocity v_{ref} calculated at the reference field F_{ref} where the mobility is reduced by a factor of 2. If Eq. (7) is applicable, then the reference velocity is equal to half the saturated velocity v_{sat} and is reached at a reference field of $F_{ref}=v_{sat}/\mu$. We find that the reference velocity is about $3 \times 10^7 - 5 \times 10^7$ cm/s and has little dependence on either carrier density or low-field mobility in the parameter space considered here. The reference field is inversely proportional to the low-field mobility as shown in Fig. 5(b), which justifies the functional form Eq. (7) used to analyze the BTE results.

IV. SELF-HEATING EFFECT ON CURRENT SATURATION

The analysis of both experimental^{11–13} and simulation¹⁶ results had often relied on Eq. (8). In Fig. 6 we show that Eq. (8) fails qualitatively to describe the results of the BTE simulations. In particular, saturated velocity in graphene on SiO₂ is predicted to be very similar to that in graphene on BN and SiC substrates, although SPP phonon energies in the latter are almost a factor of two larger. While Eq. (8) predicts a variation in v_{sat} by more than an order of magnitude for the range of n and $\hbar\Omega$ used in Fig. 6, we find the values of v_{sat} from the fits to Eq. (7) to be within $4 \times 10^7 - 8 \times 10^7$ cm/s. The saturated velocity in intrinsic graphene shown by green



FIG. 6. (Color online) Carrier-density dependence of the saturated velocity in graphene on different substrates at room temperature: green circles - intrinsic, black open circles - on BN, cyan squares - on SiC, red triangles - on SiO₂, and blue diamonds - on HfO₂. The dashed curves are predictions using Eq. (8) with optical-phonon energy $\hbar \omega_{SO_1}$ from Table I, from top to bottom: green - intrinsic, cyan - on SiC, black – on BN, red – on SiO₂, and blue – on HfO₂.

curve in Fig. 6 agrees well with the Monte Carlo BTE solution in low-density limit in Ref. 60. At the same time, the reported experimental values^{11,12} of v_{sat} at densities of 10^{13} cm⁻² are below 10^7 cm/s, which is at least a factor of four smaller than that in Fig. 6.

We suggest that one of the factors for the apparent discrepancy is the self-heating effect. The temperature rise was shown¹² to be proportional to the Joule losses $T=T_{amb}$ +jF/r, where T_{amb} is the ambient temperature and the thermal conductance r controls the heat dissipation. This simple picture applies only for graphene regions away from the contacts such that both the thermal contact resistance⁶¹ and the substrate thermal conductivity determine the value of r. Note that the upper bound for r, which corresponds to zero contact thermal resistance, is determined by the thermal conductivity and thickness of the insulating substrate. For example, thermal conductivity of SiO₂ is $\kappa \approx 1.4$ W/(mK) (Ref. 62) and for the insulator height of h=300 nm a maximum value of $r = \kappa / h \approx 0.47 \text{ kW} / (\text{K cm}^2)$ is expected. However, this upper bound can be significantly reduced due to the thermal contact resistance as in Ref. 12.

In the presence of the SPP scattering the role of the thermal contact resistance is minimized because electrons can give some of their energy directly to the substrate SPP phonons.^{63,64} In our "self-heating model" we assume that SPP and graphene phonons are heated to the same temperature, which is proportional to the Joule losses found selfconsistently, i.e., j=j(T). In substrates with much higher thermal conductivities, such as SiC, BN, and HfO₂, the thermal contact resistance would dominate the value of r. In this case a full self-consistent solution including thermal transport in the substrate, which determines the SPP phonon temperature, would be needed. In Fig. 7, we find that the current densities drop by up to a factor of 4 at high biases as a result of self-heating for r=0.47 kW/(K cm²). Moreover, the current now shows true saturation at experimental source-drain



FIG. 7. (Color online) Current density electric field dependence in graphene on different polar substrates: green circles - intrinsic, black open circles - on BN, cyan squares - on SiC, red triangles - on SiO₂, and blue diamonds - on HfO₂ at carrier densities (a) $n = 10^{12}$ cm⁻², (b) $n=5 \times 10^{12}$ cm⁻², and (c) $n=10^{13}$ cm⁻² at selfconsistent lattice temperatures $T=T_{amb}+j(T)F/r$ for r=0.47 kW/ (K cm²), corresponding to the ideal thermal contact resistance with 300 nm SiO₂. The vertical axis on the right shows corresponding values of the maximum temperatures at 2 V/ μ m.

fields, which are much smaller than F_{ref} calculated in Fig. 5(b) at room temperatures, and the high bias currents are comparable to those reported in Refs. 11 and 12.

At high density, the self-heating involving the intrinsic graphene phonons is predicted here to lead to negativedifferential conductance. This effect has served as an experimental signature of the self-heating in suspended carbon nanotubes.⁶⁵ In the presence of SPP scattering the negativedifferential conductance is less pronounced and the selfheating effect leads to current saturation in Fig. 7. The different outcome of self-heating effects leading to either negative-differential conductance or current saturation can well be understood by the difference in the graphene phonon and SPP phonon energies. Indeed, the current density in the diffusive regime is $j \propto F \tau$. According to Eq. (1), the selfheating reduces the scattering time as $\tau \propto (1+2N_{op})^{-1}$, such that $j \propto F/(1+2N_{op})$. In the high-temperature limit N_{op} $\propto k_B T / \hbar \omega_{op}$ and current saturates as $j \propto F / (T_{amb} + jF / r)$, where we have used the self-heating temperature $k_B T = T_{amb}$ + jF/r. The saturation current in this simple picture depends on *r* as $j_{sat} \propto r^{0.5}$, which is in qualitative agreement with a full BTE solution shown in Fig. 8(b). On the other hand, the large intrinsic graphene optical phonon leads to an activated temperature dependence of the scattering time, which produces the negative-differential conductance in Fig. 7.

The effect of the thermal conductance r on velocity saturation is explored in Fig. 8. As r is reduced from infinity to 0.25 kW/(K cm²), the saturated velocity drops by a factor



FIG. 8. (Color online) Carrier-density dependence of (a) the saturated velocity and (b) saturated current in graphene on SiO₂ using the self-heating model at different thermal conductances *r* in kW/(K cm²) from top to bottom: black - *T*=300 K or $r=\infty$, cyan – r=4.0, magenta - r=2.0, red - r=1.0, green - r=0.5, and blue - r=0.25, which correspond to the ideal thermal resistance to SiO₂ with an effective thickness $h=\kappa/r=0, 35, 70, 140, 280, and 560 nm correspondingly. The dashed black curve in (a) is calculated using Eq. (8) for SPP phonon in SiO₂. The solid squares in (b) show fitted saturated currents to Eq. (7) from Ref. 13.$

of 4. For small values of r and large densities, we find that Eq. (7) fails to fit the results of calculations in the full range of fields and, therefore, we have chosen to fit only the range of fields from 0.5 to 1 V/ μ m, where saturation is almost attained. In Fig. 9(a) we show a fit of the data from Ref. 13 to Eq. (7) and extract the values of the saturation currents. The latter agree well with our calculated saturated currents in Fig. 8(b) for $r=0.5 \text{ kW}/(\text{K cm}^2)$. Note that the saturation current in the presence of the graphene optical phonons at room temperature (see Fig. 6) underestimates the measured currents in Ref. 13 at low densities and inclusion of selfheating effects would make the agreement even worse. Note, that if one accounts for the self-heating of SPP phonons with r=0.25 kW/(K cm²), then Eq. (8) fits the calculated saturated currents in Fig. 8(a) and the resulting $\hbar\Omega$ =59 meV corresponds to the SPP phonon energy in SiO₂.

In the experiment described in Ref. 12, the thermal conductance *r* was directly measured and does not have to be a fit parameter in modeling the experimental *I-V* curve. The observed mobility of about 1000 cm²/Vs in Ref. 12 can be reproduced in our calculations by assuming scattering with charged impurities⁵² of density n_i =4.5×10¹² cm⁻² and with a smaller n_i =3.5×10¹² cm⁻² in the presence of SPP scattering from the SiO₂ substrate. The charge carrier density was fixed by the gate voltage at $n \approx 10^{13}$ cm⁻² in Ref. 12. In Fig. 9(b) we show that the calculated current is significantly larger at high biases in the presence of both intrinsic



FIG. 9. (Color online) (a) Circles show data points from Ref. 13 for V_g =24, 21, 18, 15, 12, and 9 V from top to bottom. The solid curves are fits to Eq. (7) with η =0.072 × V_g × 10¹² cm⁻², where V_g is in volts. The fit results are shown in Fig. 8(b). (b) Modeling of the current-voltage characteristics measured in Ref. 12. The green and red dashed curves, correspondingly, are BTE solutions for graphene phonon scattering and both graphene and SPP phonon scattering at T_{amb} =300 K including Coulomb scattering (see text). The green and red solid curves are self-heating model calculations with r=0.278 kW/(K cm²) (Ref. 12) including graphene phonon only, and both SPP and graphene phonon scattering, respectively. Black squares are experimental results from Ref. 12.

graphene and SPP phonon scattering at room temperatures. Most importantly, the current does not show the saturation that is observed in the experiment. On the other hand, using the experimentally measured temperatures, our self-heating model with r=0.278 kW/(K cm²) including the SPP scattering very nicely reproduces the experiment. However, if we assume self-heating model including only the graphene phonons (no SPP) we do not find full saturation, even at fields up to 2 V/ μ m, and the calculation overestimates the measured currents at high biases.

V. CONCLUSION

In conclusion, we explored the effect of current and velocity saturation on the carrier density and impurity concentration including intrinsic graphene phonons and SPP scattering on polar substrates. The observed full current saturation is simulated only when we account for the self-heating. Without self-heating, the current densities are predicted to be too high for either graphene phonon scattering or SPP scattering. While impurity scattering modifies substantially the low-field mobility, it has little effect on the saturated velocity. Furthermore, the saturated velocity depends very weakly on carrier density and the choice of substrate. These dependencies served as the basis for invoking SPP scattering for graphene on SiO₂ as the velocity saturation mechanism in Refs. 11 and 12. A more direct experimental confirmation for the SPP role in velocity saturation is desirable. We predict a factor of 4 enhancement of the saturation current if selfheating effects are minimized. This can be achieved by using an appropriate choice of substrate with high thermal conductivity, scaled down insulator thickness, and keeping the graphene/substrate contact thermal resistance low.

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